

10 9 8 7 6 5 4 3 2 1

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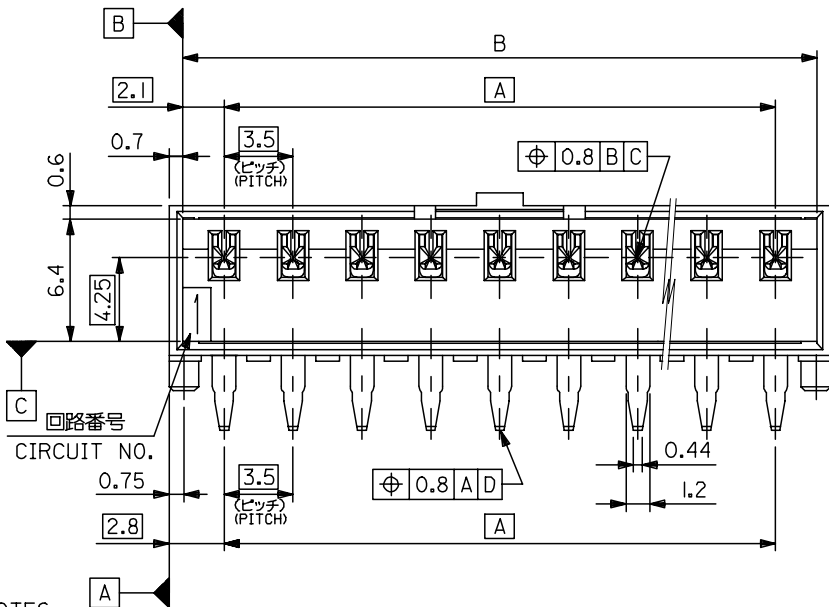
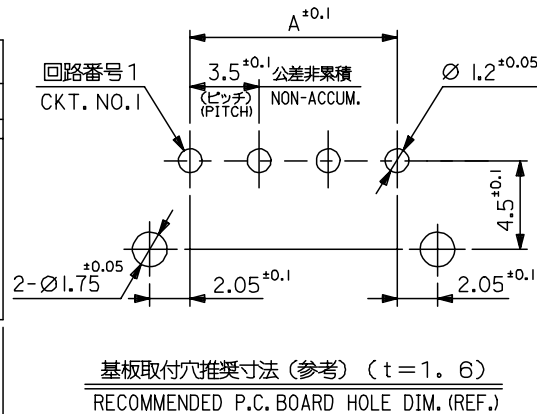
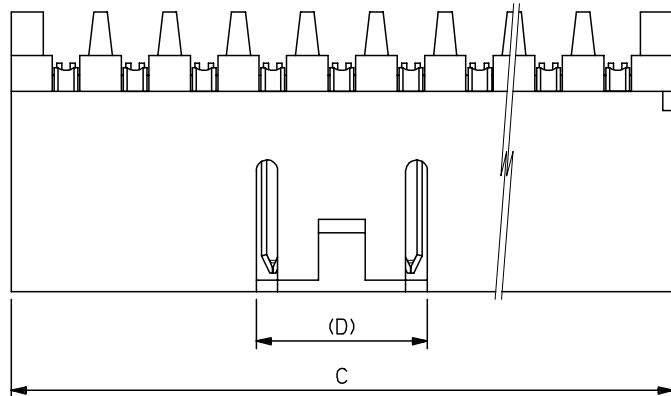
E

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8.7	54.6	53.2	49.0	53259-1520	15
				-1510	
	51.1	49.7	45.5	-1420	14
				-1410	
	47.6	46.2	42.0	-1320	13
				-1310	
	44.1	42.7	38.5	-1220	12
				-1210	
	40.6	39.2	35.0	-1120	11
				-1110	
	37.1	35.7	31.5	-1020	10
				-1010	
	33.6	32.2	28.0	-0920	9
				-0910	
	30.1	28.7	24.5	-0820	8
				-0810	
	26.6	25.2	21.0	-0720	7
				-0710	
	23.1	21.7	17.5	-0620	6
				-0610	
	19.6	18.2	14.0	-0520	5
				-0510	
8.7	16.1	14.7	10.5	-0420	4
				-0410	
6.1	12.6	11.2	7.0	-0320	3
				-0310	
6.1	9.1	7.7	3.5	-0220	2
				53259-0210	
(D)	C	B	A	ENG. NO.	CKT. 種数

注記 NOTES

1. 嵌合相手: 51067 シリーズ
MATE WITH : 51067 SERIES

2. 材質
MATERIAL

ウエハー : PBTP (ガラス15%入り)、UL94V-0
WAFER : PBTP (G.F 15%), UL94V-0

ピン : 53259-**10 [リン青銅、半田メッキ (t=0.254)]
PIN : [PHOS. BRO., SOLDER PLATED (t=0.254)]

53259-**20 [黄銅、半田メッキ (t=0.254)]
[BRASS, SOLDER PLATED (t=0.254)]

REVISED EC NO: J2008-1469 DR: NIMAYASHI 2007/10/22 CHKD: THARUYAMA 2007/10/23 APPR: NUKITA 2007/10/24 DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
	10 UNDER	± 0.2	DRAWN BY K. ASAKAWA	DATE 1989/10/13	TITLE 3.5 W/B CONN WAFER ASSY R/A			
	10 OVER 30 UNDER	± 0.25	CHECKED BY K. ASAKAWA	DATE 2002/01/18	MOLEX INCORPORATED			
	30 OVER	± 0.3	APPROVED BY T. YAMAGUCHI	DATE 2002/01/18	DOCUMENT NO. SD-53259-***0			
ANGULAR $\pm 3^\circ$		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SHEET NO. 1 OF 1		
SIZE A3				THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				

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